

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Chopra et al.

Serial No.: 10/620,002

Filed: July 14, 2003

For: SLURRY FOR USE WITH FIXED-
ABRASIVE POLISHING PADS IN
POLISHING SEMICONDUCTOR DEVICE
CONDUCTIVE STRUCTURES THAT
INCLUDE COPPER AND A COPPER
BARRIER (as amended)

Confirmation No.: 7481

Examiner: L. Umez-Eronini

Group Art Unit: 1765

Attorney Docket No.: 2269-4373.2US
(00-0036.02/US)

VIA ELECTRONIC FILING

June 20, 2007

Enter Amendment

L. J. M-E.

7/11/2007

AMENDMENT UNDER 37 C.F.R. §1.116

Mail Stop AF
Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Examiner:

This Response follows the final Office Action of April 20, 2007, the shortened statutory period for response to which expires on July 20, 2007.

Remarks begin on page 2 of this paper.